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XC6223 Series

Built-in Inrush Current Protection, 300mA High Speed LDO Voltage Regulator

■GENERAL DESCRIPTION

The XC6223 series is a high speed LDO regulator that features high accurate, low noise, high ripple rejection, low dropout and low power consumption. The series consists of a voltage reference, an error amplifier, a driver transistor, a current limiter, a phase compensation circuit, a thermal shutdown circuit and an inrush current protection circuit.

The CE function enables the circuit to be in stand-by mode by inputting low level signal. In the stand-by mode, the series enables the electric charge at the output capacitor C_L to be discharged via the internal switch, and as a result the V_{OUT} pin quickly returns to the V_{SS} level. The output stabilization capacitor C_L is also compatible with low ESR ceramic capacitors.

The output voltage is selectable in 0.05V increments within the range of 1.2V to 4.0V which fixed by laser trimming technologies. The over current protection circuit and the thermal shutdown circuit are built-in. These two protection circuits will operate when the output current reaches current limit level or the junction temperature reaches temperature limit level.

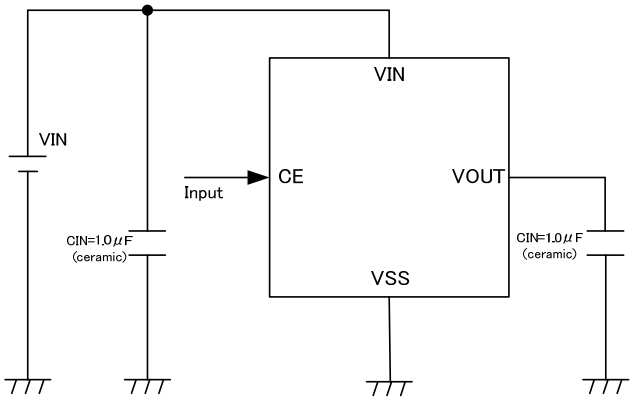
■APPLICATIONS

- ●Digital still cameras
- ●Cell phones
- ●Portable games
- ●Camera modules
- ●IC recorders
- ●Portable media players
- ●Bluetooth
- ●Wireless LAN
- ●Terrestrial digital TV tuners
- ●Cordless phones

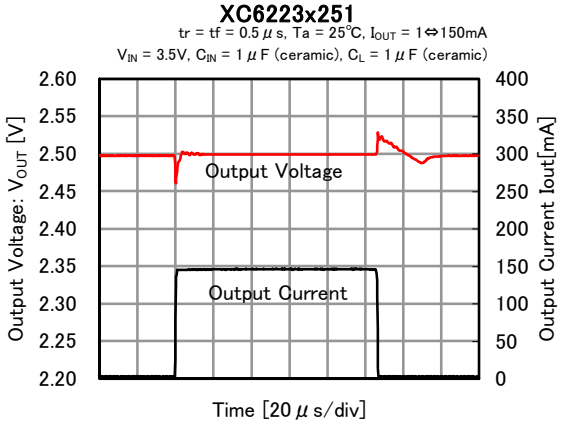
■FEATURES

Maximum Output Current	: 300mA
Input Voltage Range	: 1.6～5.5V
Output Voltages	: 2.0～4.0V（Accuracy ±1%） 1.2～1.95V（Accuracy ±20mV） 0.05V increments
Dropout Voltage	: 200mV@I_{OUT}=300mA (V_{OUT}=3.0V)
Low Power Consumption	: 100μA
Stand-by Current	: 0.1μA
High Ripple Rejection	: 80dB@f=1kHz
Protection Circuits	: Current Limit（400mA） Short Circuit Protection Over Heat Protection Inrush Current Protection
Low ESR Capacitors	: C_{IN} =1.0μF, C_L=1.0μF
CE Function	: Active High C_L High Speed Discharge
Small Packages	: USPQ-4B03 USP-4 SSOT-24 SOT-25 SOT-89-5
Environmentally Friendly	: EU RoHS Compliant, Pb Free

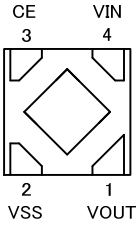
■TYPICAL APPLICATION CIRCUIT



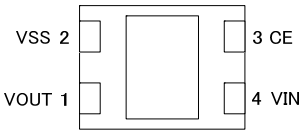
■ TYPICAL PERFORMANCE CHARACTERISTICS



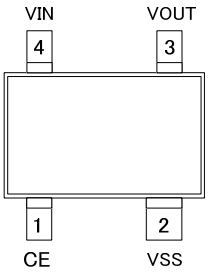
■PIN CONFIGURATION



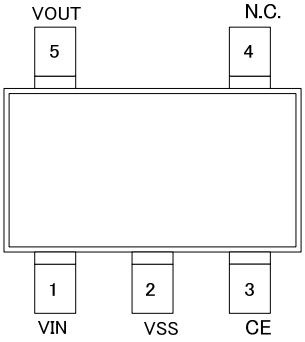
USPQ-4B03
(BOTTOM VIEW)



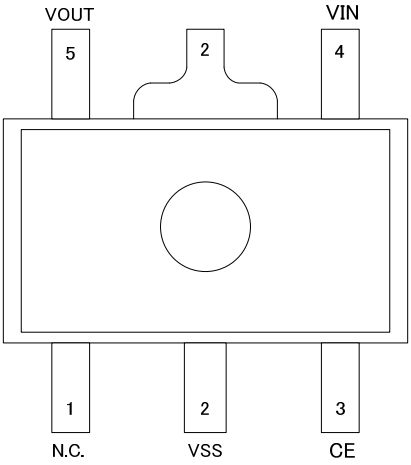
USP-4
(BOTTOM VIEW)



SSOT-24
(TOP VIEW)



SOT-25
(TOP VIEW)



SOT-89-5
(TOP VIEW)

*The dissipation pad for the USPQ-4B03,USP-4 packages should be solder-plated in reference mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the V_{SS} (No. 2) pin.

■PIN ASSIGNMENT

PIN NUMBER					PIN NAME	FUNCTIONS
USPQ-4B03	USP-4	SSOT-24	SOT-25	SOT-89-5		
4	4	4	1	4	V_{IN}	Power Input
1	1	3	5	5	V_{OUT}	Output
2	2	2	2	2	V_{SS}	Ground
3	3	1	3	3	CE	ON/OFF Control
-	-	-	4	1	NC	No Connection

■PIN FUNCTION ASSIGNMENT

CE Ethics Condition	IC Operation State ON/OFF
H	Operation ON
L	Operation OFF(Stand-by)
OPEN	*

* Undefined state in XC6223 A/B/E/F. On the other hand, Operation OFF states in XC6223C/D/G/H because that an internal pull-down resister maintains the CE pin voltage to be low.

■PRODUCT CLASSIFICATION

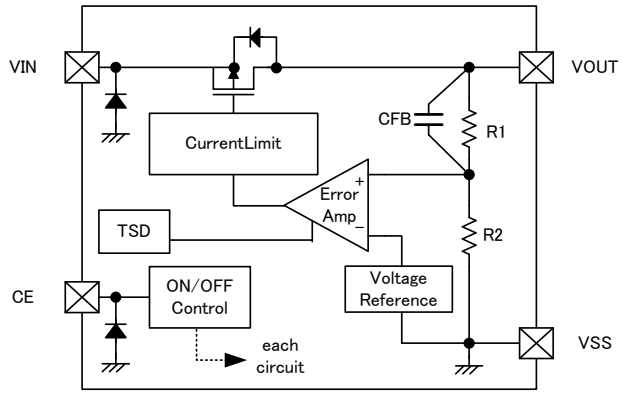
●Ordering Information

XC6223①②③④⑤⑥-⑦(*1)

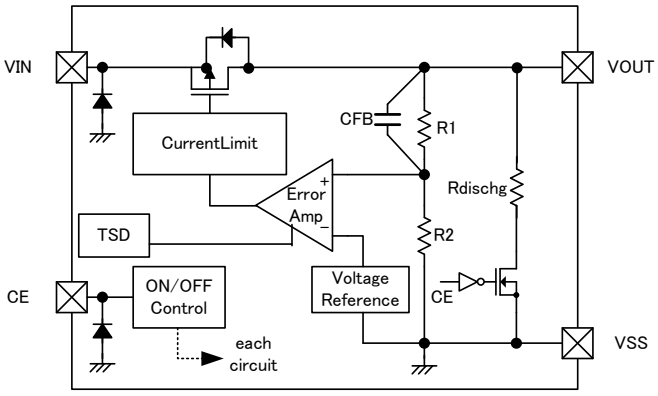
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION		
			Inrush Current Protection	CE Pull-Down Resistor	C_L Discharge
①	Type of Regulator (CE active high)	A	NO	NO	NO
		B	NO	NO	YES
		C	NO	YES (1MΩ, TYP built-in)	NO
		D	NO	YES (1MΩ, TYP built-in)	YES
		E	YES	NO	NO
		F	YES	NO	YES
		G	YES	YES (1MΩ, TYP built-in)	NO
		H (The Recommended Type)	YES	YES (1MΩ, TYP built-in)	YES
②③	Output Voltage	12～40	ex.) 2.80V → ②=2, ③=8, ④=please see down below.		
④	Output Voltage (2^{nd} decimal place)	1	ex.) 2.80V → ④=1		
		B	ex.) 2.85V → ④=B		
⑤⑥-⑦(*1)	Packages (Order Unit)	9R-G	USPQ-4B03 (5,000/Reel)		
		GR-G	USP-4 (3,000/Reel)		
		NR-G	SSOT-24 (3,000/Reel)		
		MR-G	SOT-25 (3,000/Reel)		
		PR-G	SOT-89-5 (3,000/Reel)		

(*1) The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

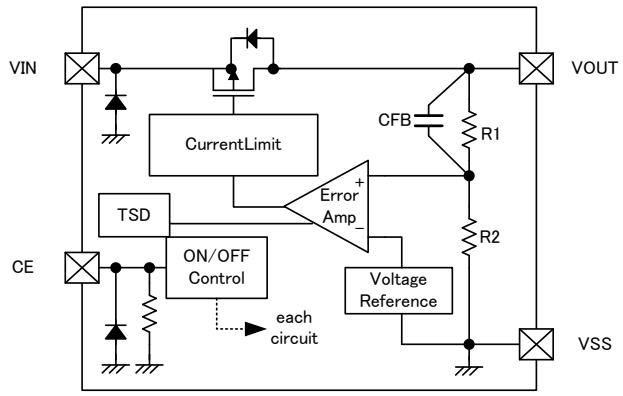
■BLOCK DIAGRAMS



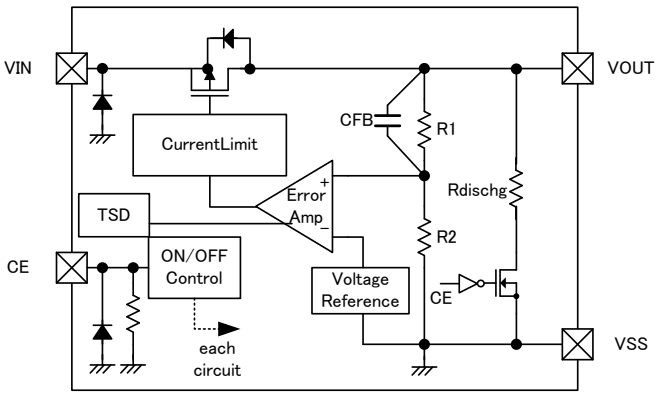
XC6223Aseries



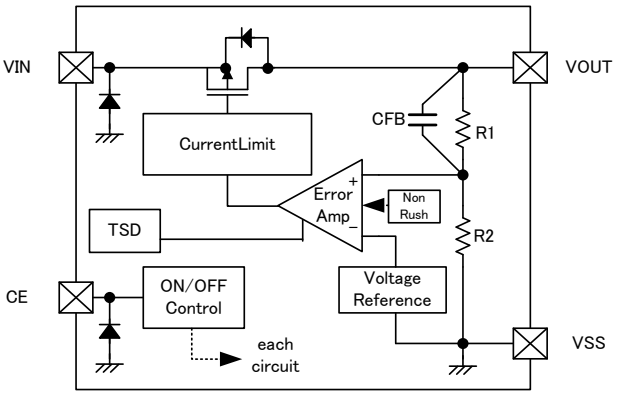
XC6223Bseries



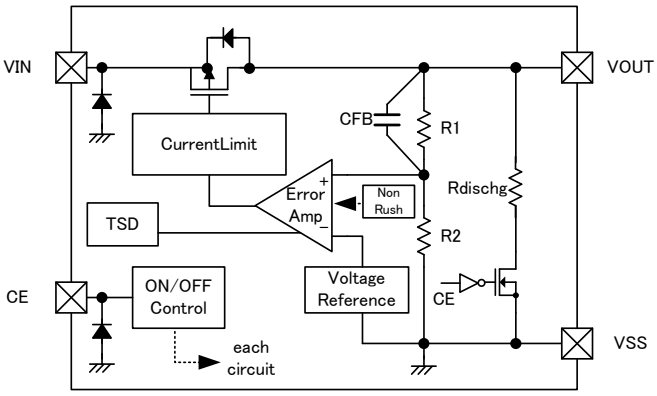
XC6223Cseries



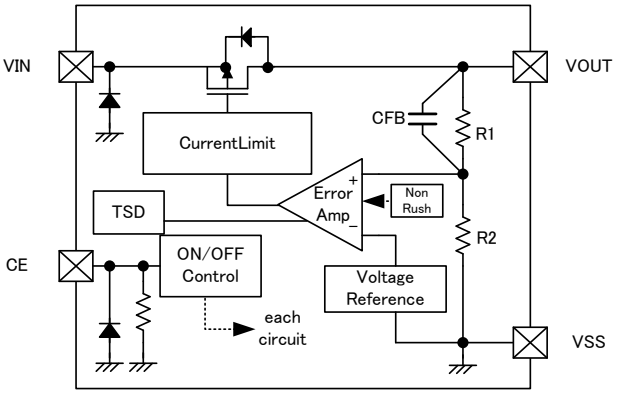
XC6223Dseries



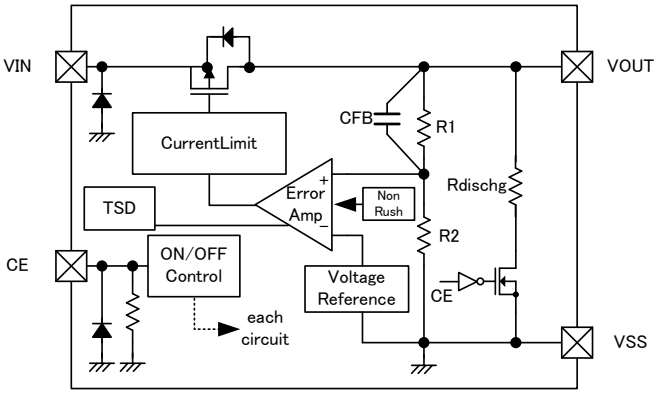
XC6223Eseries



XC6223Fseries



XC6223Gseries



XC6223Hseries

■ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V_{IN}	V_{SS}-0.3～+7.0	V
Output Current		I_{OUT}	500 (*1)	mA
Output Voltage		V_{OUT}	V_{SS}-0.3～V_{IN}+0.3	V
CE Input Voltage		V_{CE}	V_{SS}-0.3～+7.0	V
Power Dissipation	USPQ-4B03	Pd	100	mW
			550 (PCB mounted) (*2)	
	USP-4		120	
			1000 (PCB mounted) (*2)	
	SSOT-24		150	
			500 (PCB mounted) (*2)	
	SOT-25		250	
			600 (PCB mounted) (*2)	
	SOT-89-5		500	
			1300 (PCB mounted) (*2)	
Operating Temperature Range		Topr	-40～+85	℃
Storage Temperature Range		Tstg	-55～+125	℃

(*1) : $I_{OUT} \leqq Pd / (V_{IN}-V_{OUT})$

(*2) : The power dissipation figure shown is PCB mounted. Please refer to page 26～29 for details.

■ELECTRICAL CHARACTERISTICS

●XC6223A/B/C/D/E/F/G/H Series

Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Output Voltage	$V_{OUT(E)}$ (*1)	$V_{OUT(T)} \geqq 2.0V$, $V_{CE}=V_{IN}$, $I_{OUT}=10mA$	$V_{OUT(T)} \times 0.99$ (*2)	$V_{OUT(T)}$ (*2)	$V_{OUT(T)} \times 1.01$ (*2)	V	①
		$V_{OUT(T)} < 2.0V$, $V_{CE}=V_{IN}$, $I_{OUT}=10mA$ (*3)	$V_{OUT(T)}-20mV$ (*2)	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}+20mV$ (*2)	V	
Maximum Output Current	$I_{OUT}MAX$	$V_{CE}=V_{IN}$	300	-	-	mA	①
Load Regulation	ΔV_{OUT}	$V_{CE}=V_{IN}$, $0.1mA \leqq I_{OUT} \leqq 300mA$	-	25	45	mV	①
Dropout Voltage	Vdif (*4)	$V_{CE}=V_{IN}$, $I_{OUT}=300mA$	E-1			mV	①
Supply Current	I_{SS}	$V_{CE}=V_{IN}$	-	100	220	μA	②
Stand-by Current	Istby	$V_{CE}=V_{SS}$	-	0.01	0.4	μA	②
Line Regulation	$\Delta V_{OUT}/(\Delta V_{IN} \cdot V_{OUT})$	$V_{OUT(T)}+0.5V \leqq V_{IN} \leqq 5.5V$, $V_{CE}=V_{IN}$, $I_{OUT}=50mA$	-	0.01	0.1	%/V	①
Input Voltage	V_{IN}	-	1.6	-	5.5	V	①
Output Voltage Temperature Characteristics	$\Delta V_{OUT}/(\Delta Ta \cdot V_{OUT})$	$V_{CE}=V_{IN}$, $I_{OUT}=10mA$, $-40℃ \leqq Ta \leqq 85℃$	-	±100	-	ppm / ℃	①
Ripple Rejection Rate	PSRR	$V_{OUT(T)} < 2.5V$, $V_{IN}=3.0V_{DC}+0.5Vp\text{-}p_{AC}$, $V_{CE}=V_{OUT(T)}+1.0V$, $I_{OUT}=30mA$、f=1kHz	-	80	-	dB	③
		$V_{OUT(T)} \geqq 2.5V$, $V_{IN}=\{V_{OUT(T)}+1.0\}V_{DC}+0.5Vp\text{-}p_{AC}$, $V_{CE}=V_{OUT(T)}+1.0V$, $I_{OUT}=30mA$、f=1kHz					
Current Limit	I_{LIM}	$V_{CE}=V_{IN}$	310	400	-	mA	①
Short Current	I_{SHORT}	$V_{CE}=V_{IN}$, $V_{OUT}=V_{SS}$	-	50	-	mA	①
CE High Level Voltage	V_{CEH}	-	1.0	-	5.5	V	④
CE Low Level Voltage	V_{CEL}	-	-	-	0.3	V	④
CE High Level Current (A/B/E/F Type)	I_{CEH}	$V_{CE}=V_{IN}=5.5V$	-0.1	-	0.1	μA	④
CE High Level Current (C/D/G/H Type)	I_{CEH}	$V_{CE}=V_{IN}=5.5V$	3.0	5.5	9.0	μA	④
CE Low Level Current	I_{CEL}	$V_{CE}=V_{SS}$	-0.1	-	0.1	μA	④
CL Discharge Resistance (Only B/D/F/H Type)	R_{DCHG}	$V_{IN}=5.5V$, $V_{OUT}=2.0V$, $V_{CE}=V_{SS}$	-	300	-	Ω	①
Inrush Current (Only E/F/G/H Type)	Irush	$V_{IN}=V_{CE}=5.5V$	-	150	-	mA	⑤
Thermal Shutdown Detect Temperature	T_{TSD}	Junction Temperature	-	150	-	℃	①
Thermal Shutdown Release Temperature	T_{TSR}	Junction Temperature	-	120	-	℃	
Thermal Shutdown Hysteresis Width	T_{TSD} - T_{TSR}	Junction Temperature	-	30	-	℃	

NOTE:

*1: $V_{OUT(E)}$: Effective output voltage
(i.e. the output voltage when "$V_{OUT(T)}+1.0V$" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.)

*2: $V_{OUT(T)}$: Nominal output voltage

*3: The standard output voltage is specified in $V_{OUT(T)} \pm 20mV$ where $V_{OUT(T)} < 2.0V$.

*4: $Vdif = \{V_{IN1}\{*5\} - V_{OUT1}\{*6\}\}$ ($V_{IN1} \geqq 1.6V$)

*5: V_{IN1}=The input voltage when V_{OUT1} appears as input voltage is gradually decreased.

*6: V_{OUT1}=A voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} $\{V_{OUT(T)}+1.0V\}$ is input

*7: Unless otherwise stated regarding input voltage conditions, $V_{IN}=V_{OUT(T)}+1.0V$.

■ELECTRICAL CHARACTERISTICS (Continued)

●Voltage Chart 1

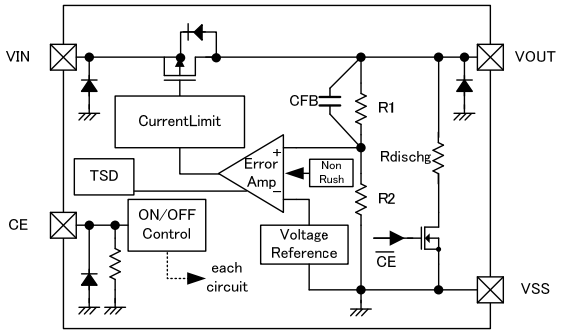
SYMBOL	E-0		E-1	
PARAMETER / NOMINAL OUTPUT VOLTAGE (V)	OUTPUT VOLTAGE (V)		DROPOUT VOLTAGE (mV)	
$V_{OUT(T)}$	$V_{OUT(E)}$		Vdif	
	MIN	MAX	TYP	MAX
1.20	1.1800	1.2200	480	630
1.25	1.2300	1.2700		
1.30	1.2800	1.3200	440	480
1.35	1.3300	1.3700		
1.40	1.3800	1.4200	420	460
1.45	1.4300	1.4700		
1.50	1.4800	1.5200		
1.55	1.5300	1.5700		
1.60	1.5800	1.6200	400	440
1.65	1.6300	1.6700		
1.70	1.6800	1.7200		
1.75	1.7300	1.7700		
1.80	1.7800	1.8200	300	410
1.85	1.8300	1.8700		
1.90	1.8800	1.9200		
1.95	1.9300	1.9700		
2.00	1.9800	2.0200	270	380
2.05	2.0295	2.0705		
2.10	2.0790	2.1210		
2.15	2.1285	2.1715		
2.20	2.1780	2.2220		
2.25	2.2275	2.2725		
2.30	2.2770	2.3230		
2.35	2.3265	2.3735		
2.40	2.3760	2.4240		
2.45	2.4255	2.4745		
2.50	2.4750	2.5250	240	350
2.55	2.5245	2.5755		
2.60	2.5740	2.6260		
2.65	2.6235	2.6765		
2.70	2.6730	2.7270		
2.75	2.7225	2.7775		

■ELECTRICAL CHARACTERISTICS (Continued)

●Voltage Chart2

SYMBOL	E-0		E-1	
PARAMETER / NOMINAL OUTPUT VOLTAGE (V)	OUTPUT VOLTAGE (V)		DROPOUT VOLTAGE (mV)	
$V_{OUT(T)}$	$V_{OUT(E)}$		Vdif	
	MIN.	MAX.	TYP.	MAX.
2.80	2.7720	2.8280	240	350
2.85	2.8215	2.8785		
2.90	2.8710	2.9290		
2.95	2.9205	2.9795		
3.00	2.9700	3.0300	200	305
3.05	3.0195	3.0805		
3.10	3.0690	3.1310		
3.15	3.1185	3.1815		
3.20	3.1680	3.2320		
3.25	3.2175	3.2825		
3.30	3.2670	3.3330		
3.35	3.3165	3.3835		
3.40	3.3660	3.4340		
3.45	3.4155	3.4845		
3.50	3.4650	3.5350		
3.55	3.5145	3.5855		
3.60	3.5640	3.6360		
3.65	3.6135	3.6865		
3.70	3.6630	3.7370		
3.75	3.7125	3.7875		
3.80	3.7620	3.8380		
3.85	3.8115	3.8885		
3.90	3.8610	3.9390		
3.95	3.9105	3.9895		
4.00	3.9600	4.0400		

■ OPERATIONAL EXPLANATION



The voltage divided by resistors R1 & R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET which is connected to the VOUT pin is then driven by the subsequent output signal. The output voltage at the VOUT pin is controlled and stabilized by a system of negative feedback. The current limit circuit and short circuit protection operate in relation to the level of output current and heat dissipation. Further, the IC's internal circuitry can be shutdown via the CE pin signal.

<Low ESR Capacitor>

The XC6223 series needs an output capacitor C_L for phase compensation. In order to ensure the stable phase compensation, please place an output capacitor of 1.0 μF or bigger at the V_{OUT} pin and V_{SS} pin as close as possible. For a stable power input, please connect an input capacitor (C_{IN}) of 1.0 μF between the V_{IN} pin and the V_{SS} pin.

<Current Limiter, Short-Circuit Protection>

The protection circuit operates as a combination of an output current limiter and fold-back short circuit protection. When load current reaches the current limit level, the output voltage drops. As a result, the load current starts to reduce with showing fold-back curve. The output current finally falls at the level of 50mA when the output pin is short-circuited.

<CE Pin>

The IC's internal circuitry can be shutdown via the signal from the CE pin. In shutdown mode, the XC6223B/D/F/H series enables the electric charge at the output capacitor (C_L) to be discharged via the internal auto-discharge switch, and as a result the V_{OUT} pin quickly returns to the V_{SS} level. When the CE pin is open, the output voltage becomes undefined state in the XC6223A/B/E/F series because of a high active and no pull-down. On the other hand, the XC6223C/D/G/H series has a pull-down resistor at the CE pin inside, so that the CE pin input current flows.

<Thermal Shutdown>

The over heat protection circuit is built-in with the XC6223 series. When the junction temperature of the IC reaches the temperature limit level (150℃ TYP.), the thermal shutdown circuit operates and the driver transistor will be turned off. The IC resumes its operation when the thermal shutdown function is released as a result of the junction temperature drops to the release point.

<Inrush Current Protection>

The inrush current protection circuit is built in the XC6223 series.

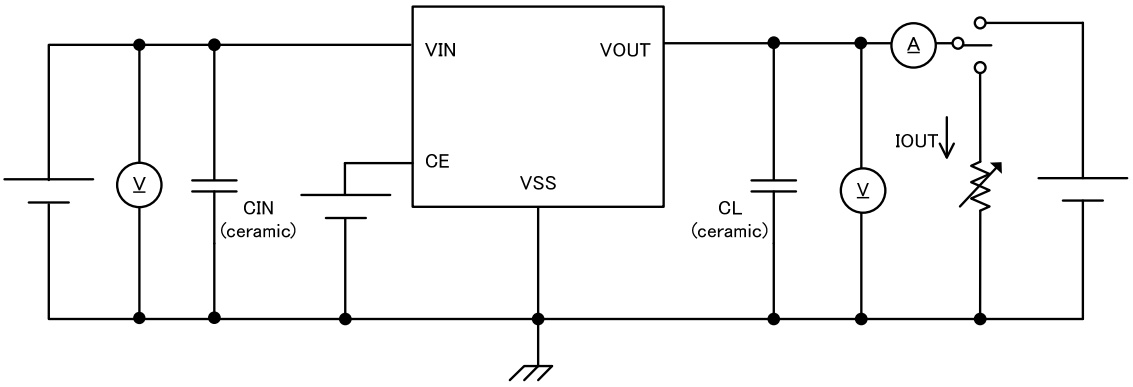
When the IC starts to operate, the protection circuit limits the inrush current from V_{IN} to V_{OUT} to charge C_L capacitor. This function is built in the XC6223E/F/G/H series.

■ NOTES ON USE

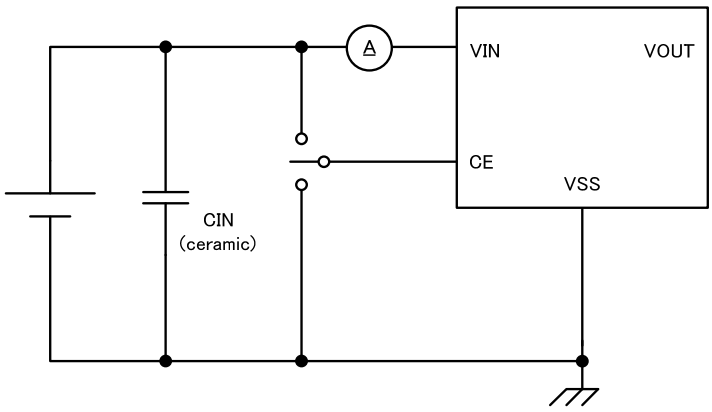
1. Where wiring impedance is high, operations may become unstable due to the noise and/or phase lag depending on output current. Please strengthen V_{IN} and V_{SS} wiring in particular.
2. The input capacitor C_{IN} and the output capacitor C_L should be placed to the as close as possible with a shorter wiring.
3. The IC is controlled with constant current start-up. Start-up sequence control is requested to draw a load current after rising up the output voltage.
4. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
5. Torex places an importance on improving our products and its reliability.
   However, by any possibility, we would request user fail-safe design and post-aging treatment on system or equipment.

■TEST CIRCUITS

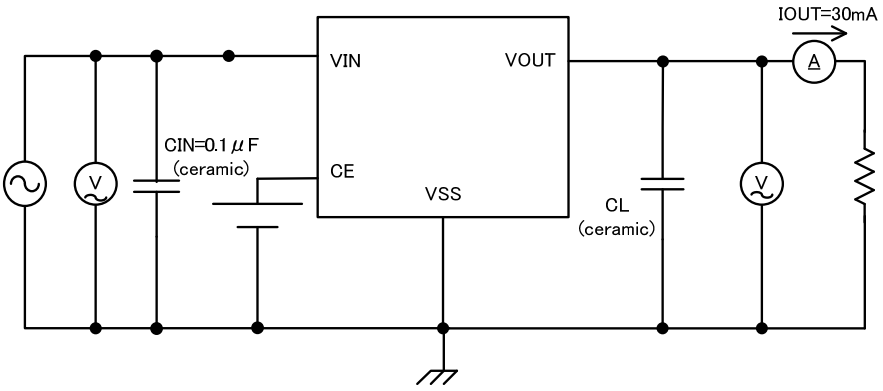
●Circuit ①



●Circuit ②

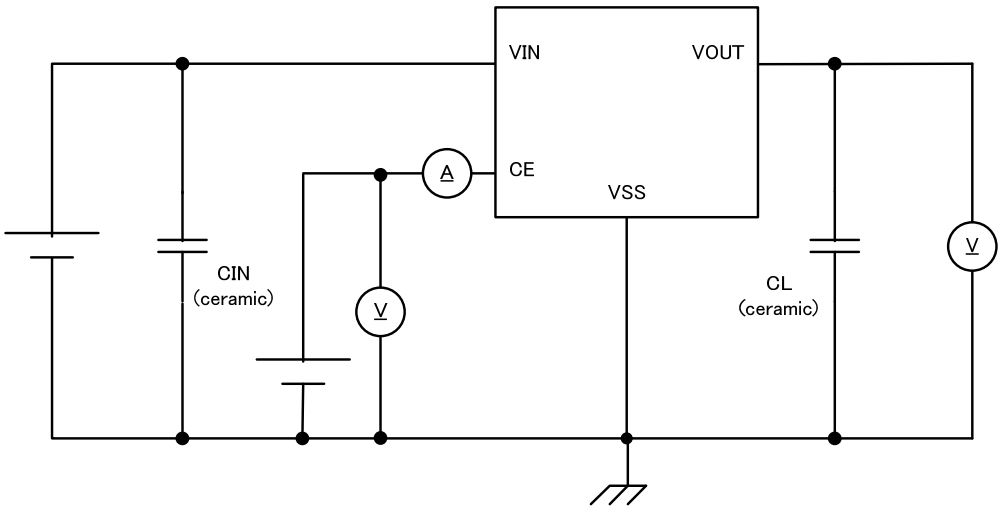


●Circuit ③

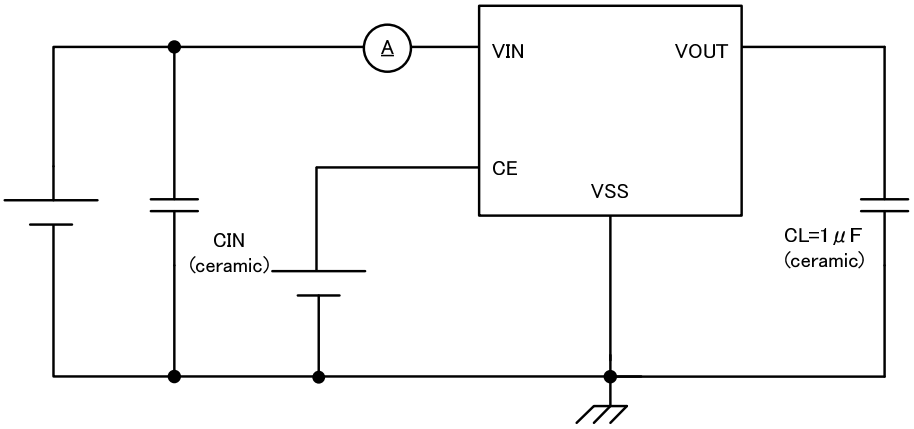


■TEST CIRCUITS (Continued)

●Circuit ④



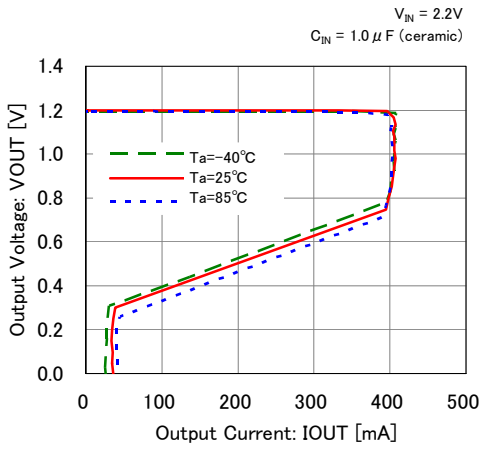
●Circuit ⑤



■TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current

XC6223x121



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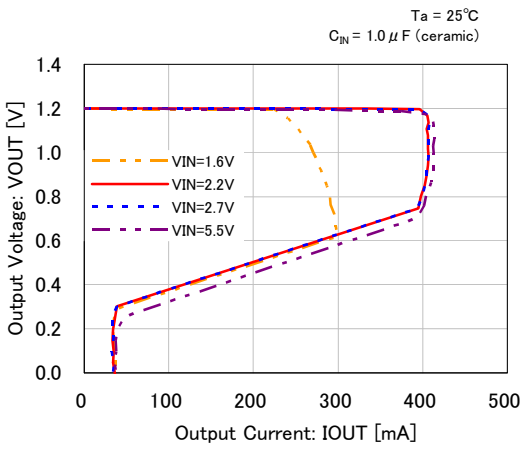

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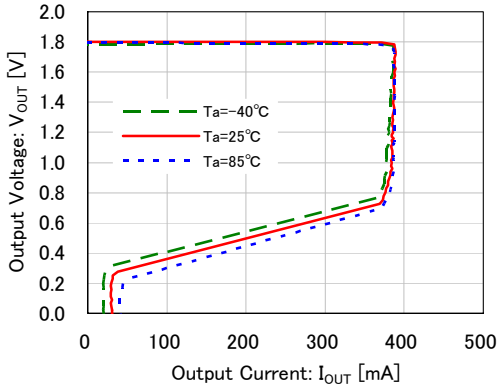

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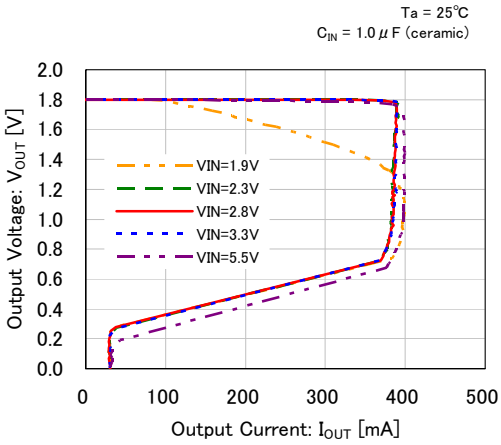

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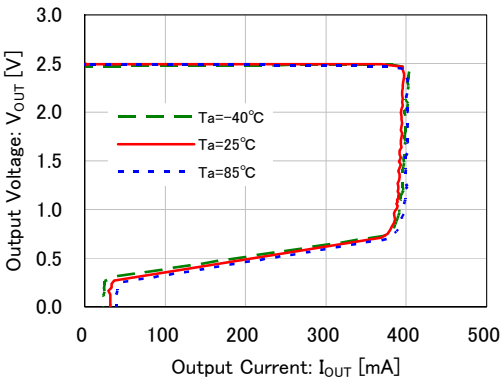

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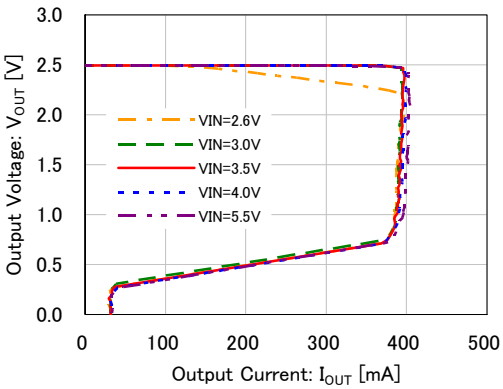
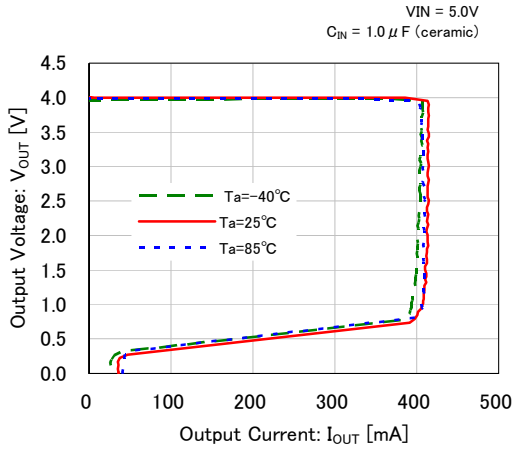


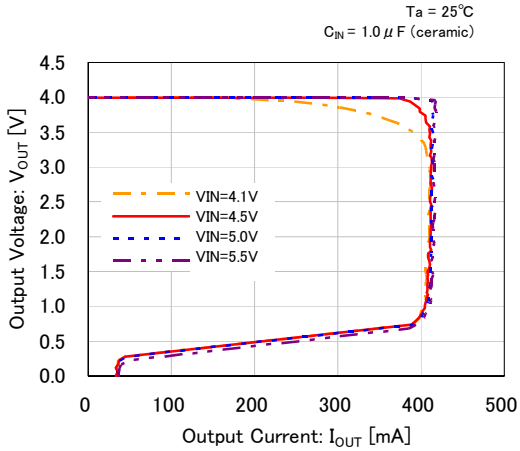
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(1) Output Voltage vs. Output Current (Continued)

XC6223x401

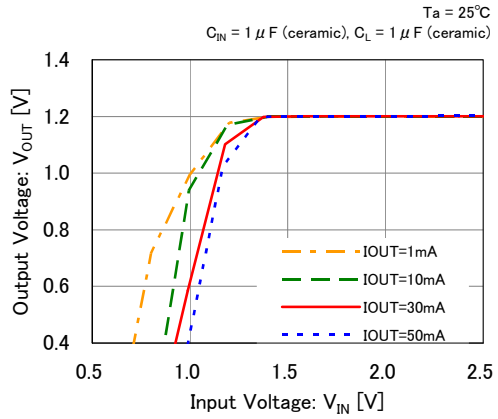


XC6223x401

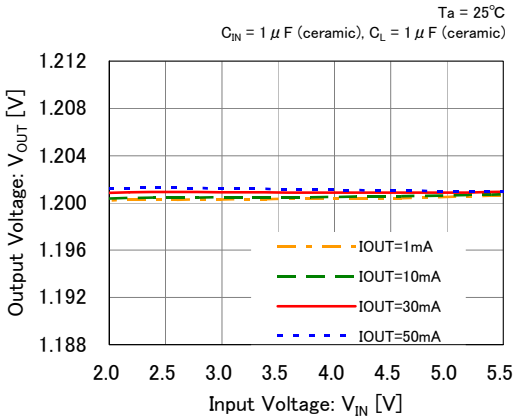


(2) Output Voltage vs. Input Voltage

XC6223x121



XC6223x121



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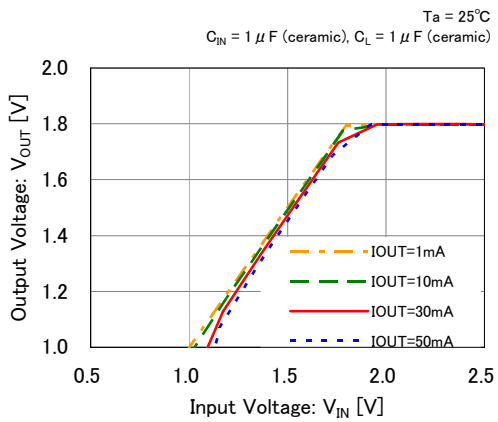

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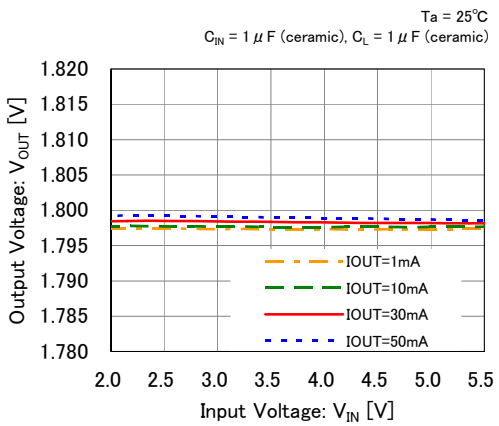
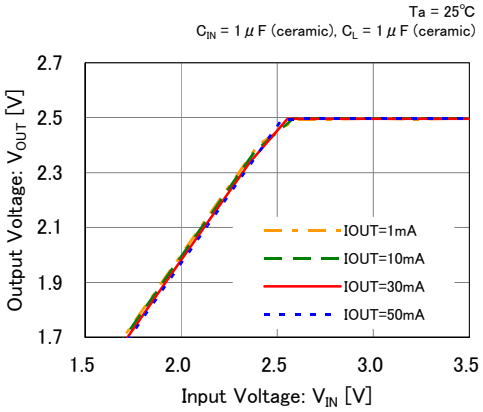


■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage (Continued)

XC6223x251



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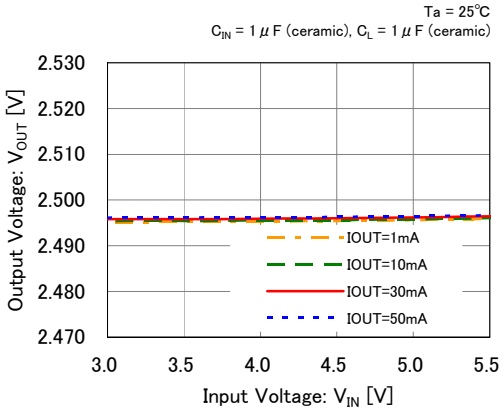

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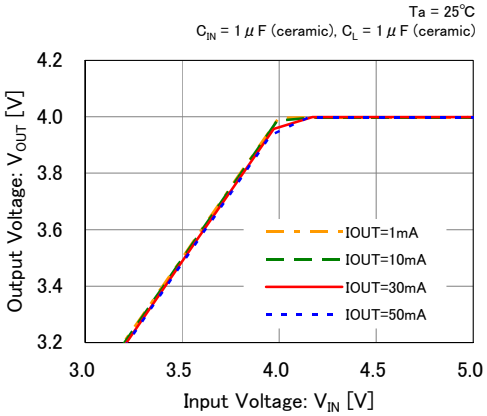
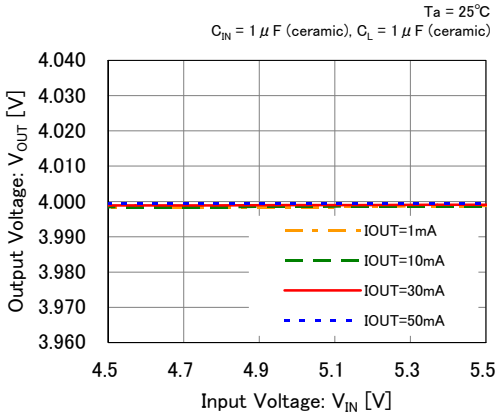
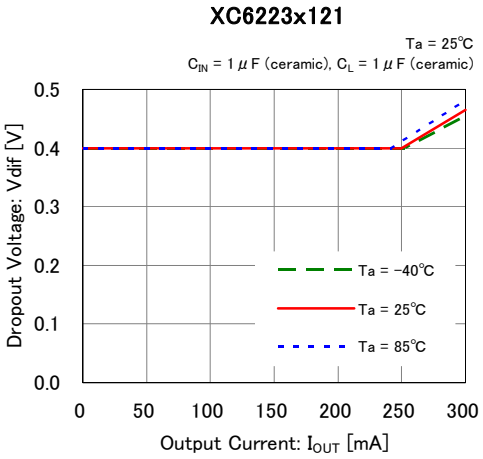


XC6223x401

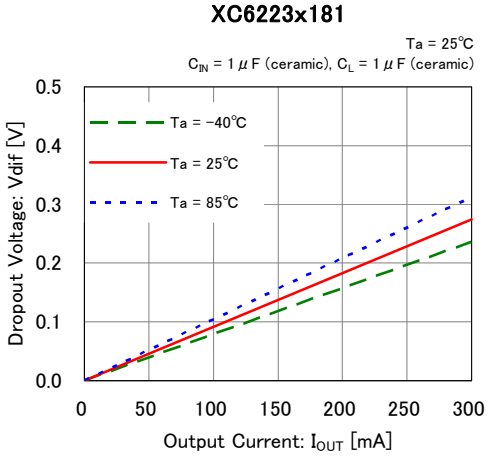


(3) Dropout Voltage vs. Output Current

XC6223x121



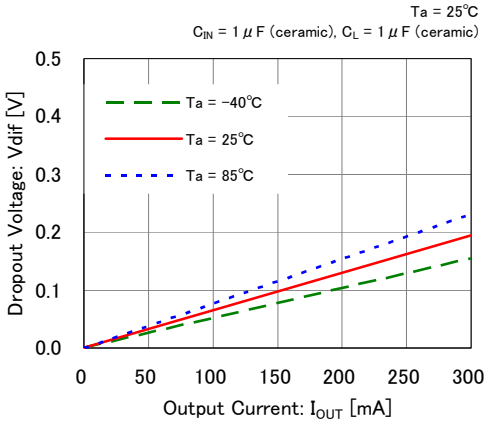
XC6223x181



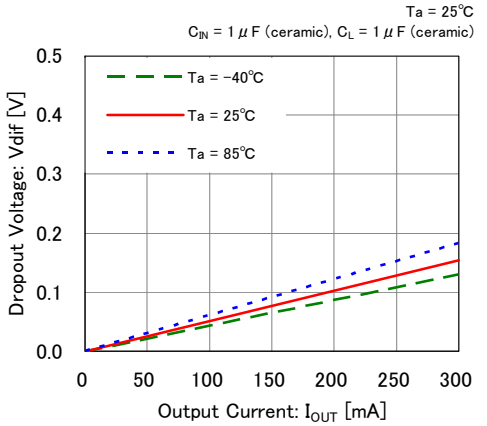
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current (Continued)

XC6223x251

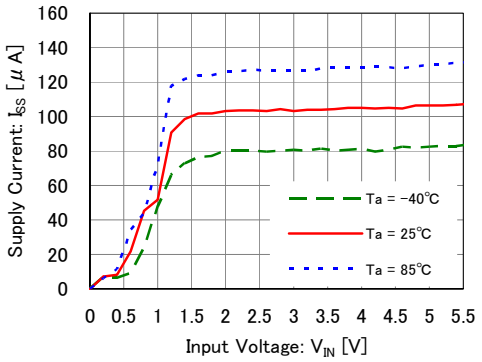


XC6223x401

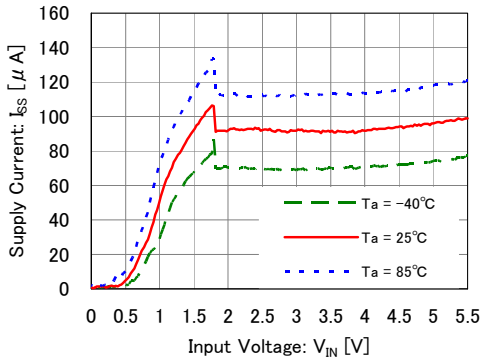


(4) Supply Current vs. Input Voltage

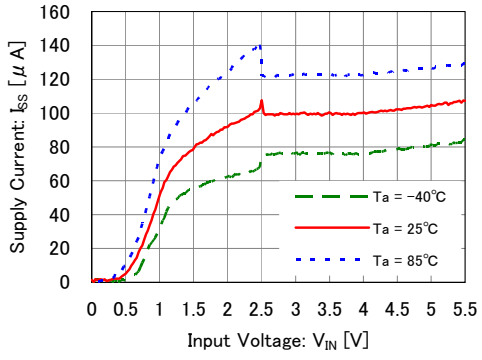
XC6223x121



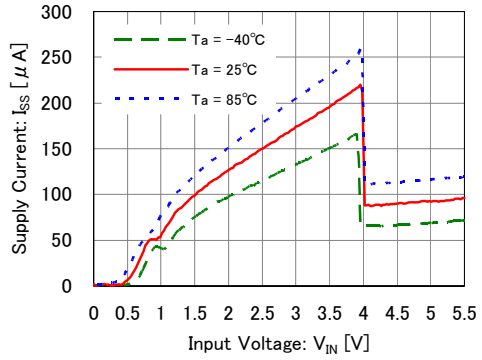
XC6223x181



XC6223x251



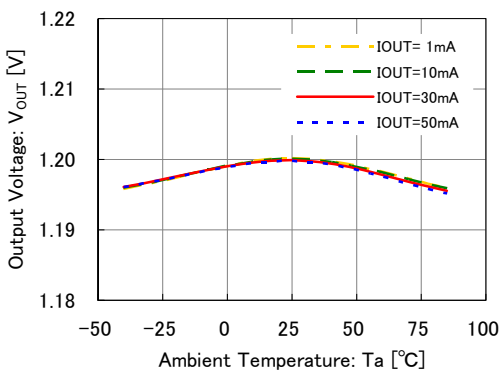
XC6223x401



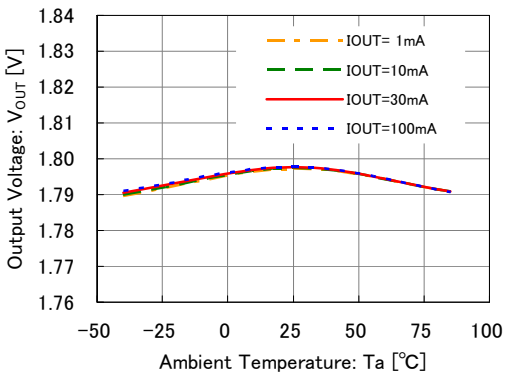
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Ambient Temperature

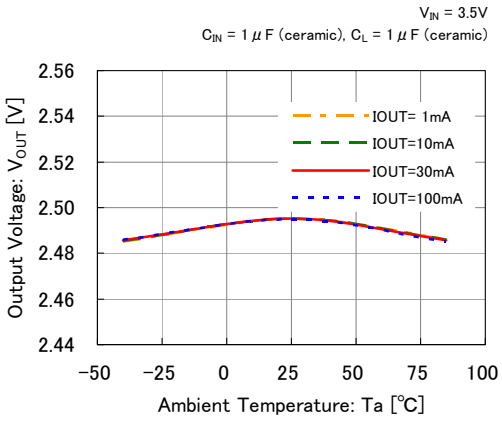
XC6223x121



XC6223x181



XC6223x251



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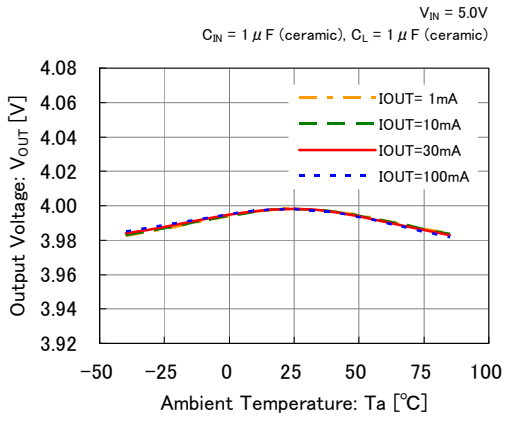
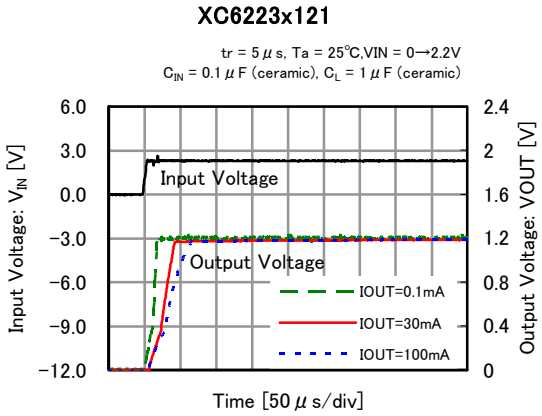
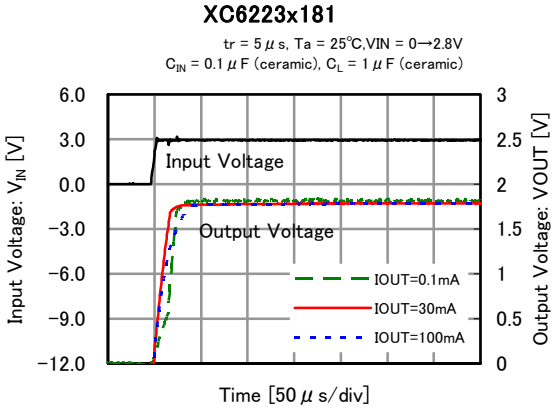


(6) Rising Response Time

XC6223x121



XC6223x181

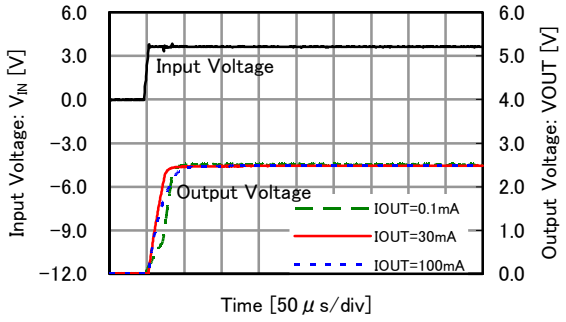


■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) Rising Response Time (Continued)

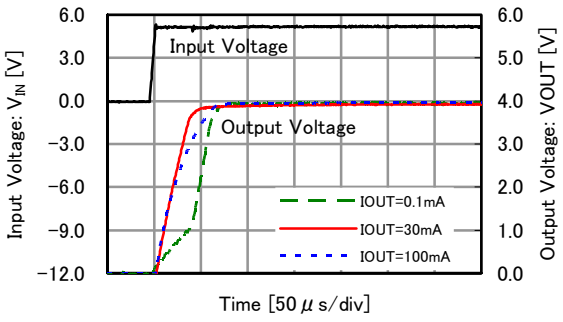
XC6223x251

tr = 5μs, Ta = 25℃,VIN = 0→3.5V
CIN = 0.1μF (ceramic), C_L = 1μF (ceramic)



XC6223x401

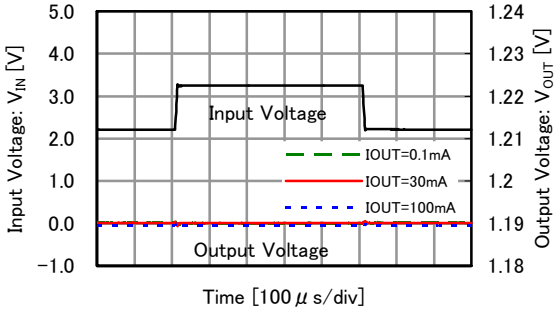
tr = 5μs, Ta = 25℃,VIN = 0→5.0V
C_{IN} = 0.1μF (ceramic), C_L = 1μF (ceramic)



(7) Input Transient Response

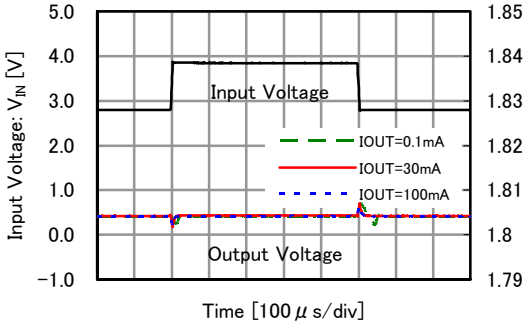
XC6223x121

tr = tf = 5μs, Ta = 25℃, VIN = 2.2V⇔3.2V
C_{IN} = 0.1μF (ceramic), CL = 1.0μF (ceramic)



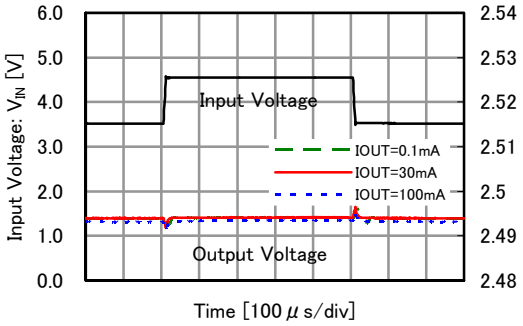
XC6223x181

tr = tf = 5μs, Ta = 25℃, VIN = 2.8V⇔3.8V
C_{IN} = 0.1μF (ceramic), CL = 1.0μF (ceramic)



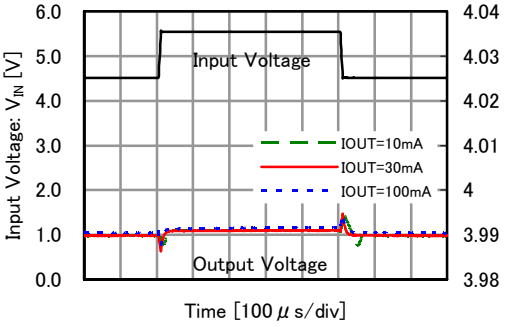
XC6223x251

tr = tf = 5μs, Ta = 25℃, VIN = 3.5V⇔4.5V
C_{IN} = 0.1μF (ceramic), CL = 1.0μF (ceramic)



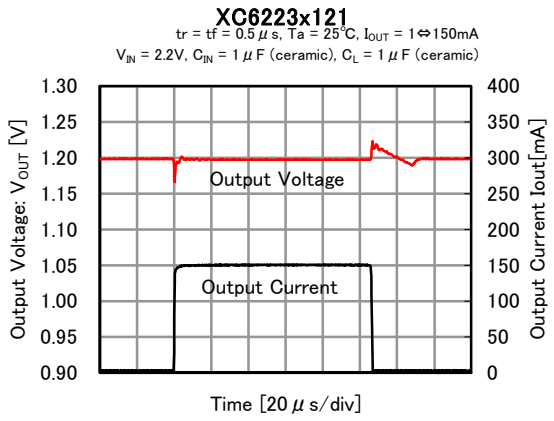
XC6223x401

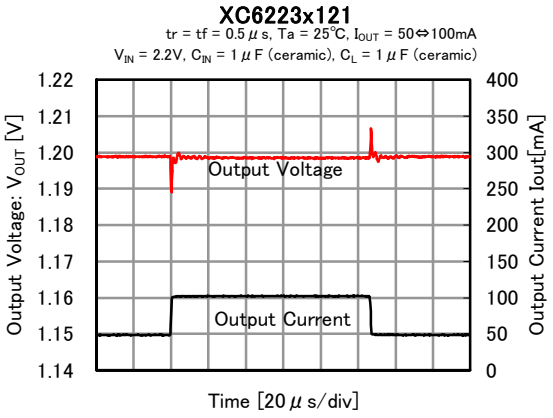
tr = tf = 5μs, Ta = 25℃, VIN = 4.5V⇔5.5V
C_{IN} = 0.1μF (ceramic), CL = 1.0μF (ceramic)

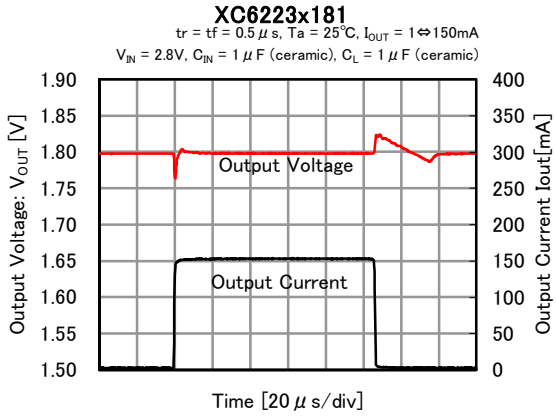


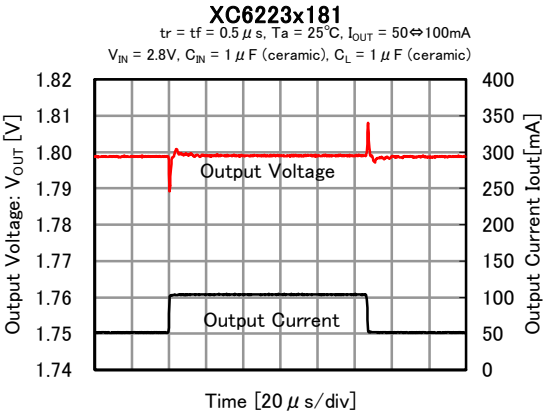
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

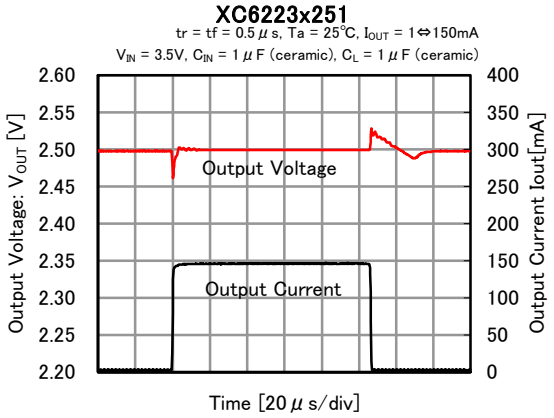
(8) Load Transient Response (tr=tf=0.5μs)

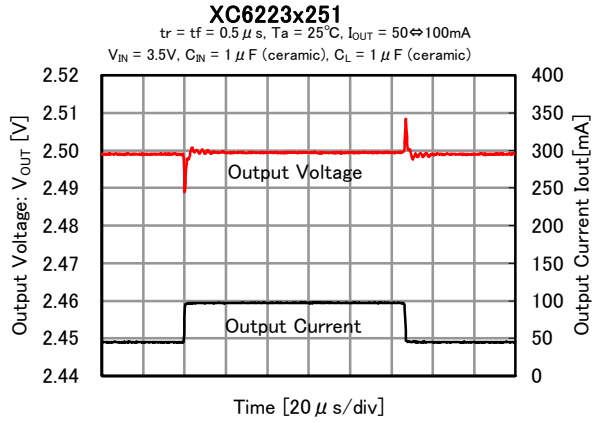






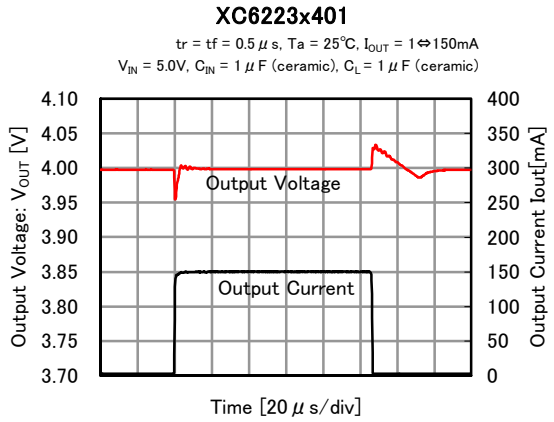


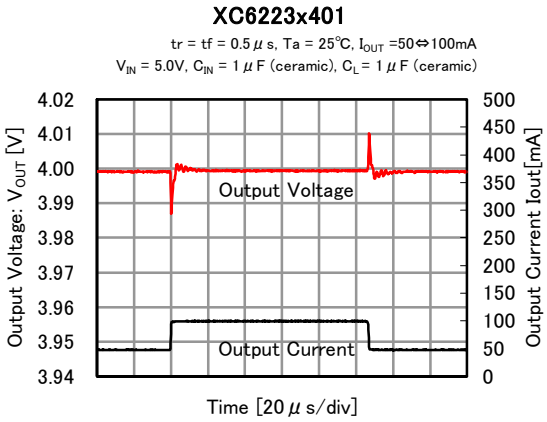




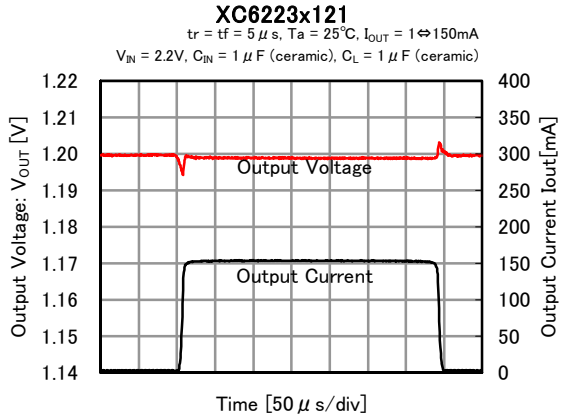
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

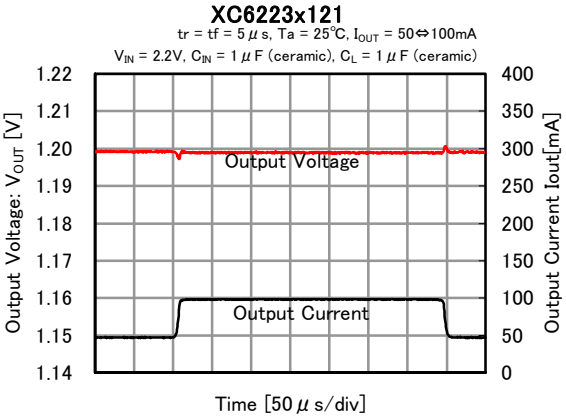
(8) Load Transient Response (tr=tf=0.5μs) (Continued)

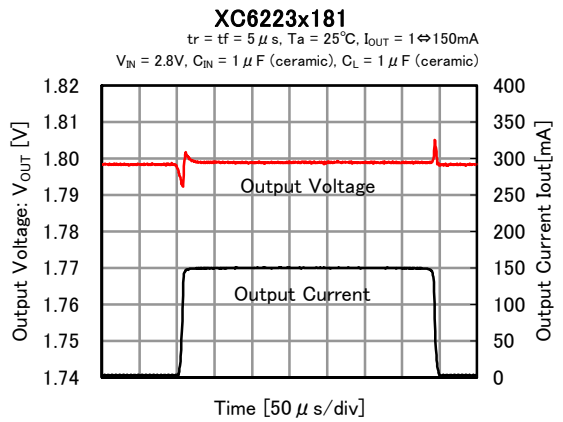


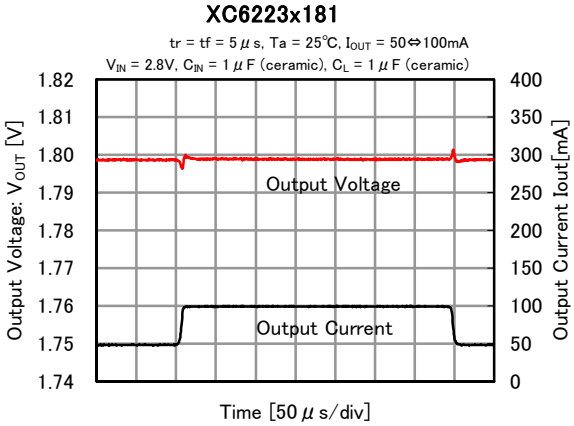


(8) Load Transient Response (tr=tf=5μs) (Continued)



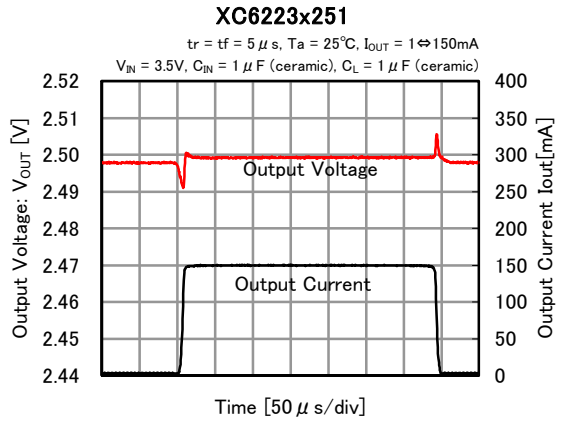


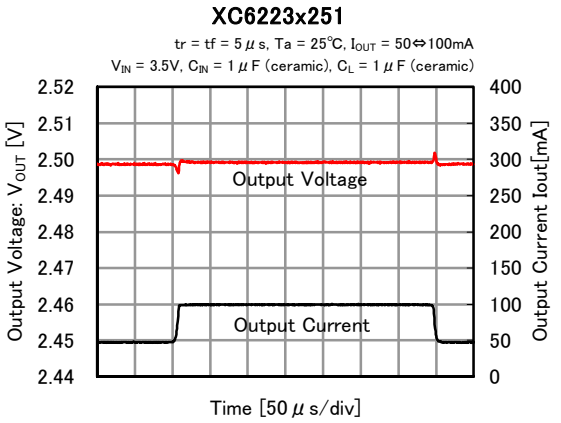


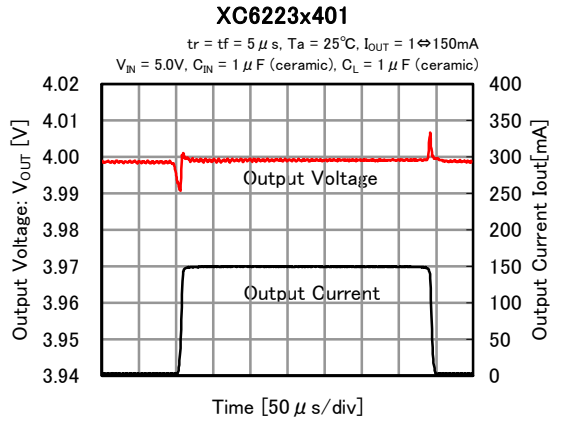


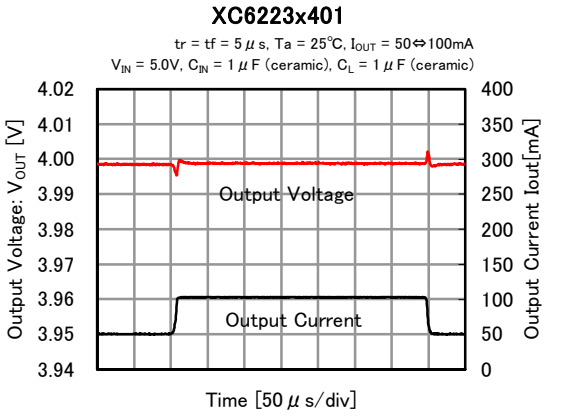
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response (tr=tf=5μs) (Continued)

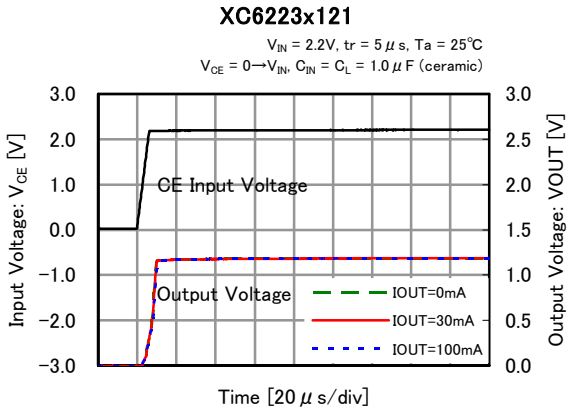


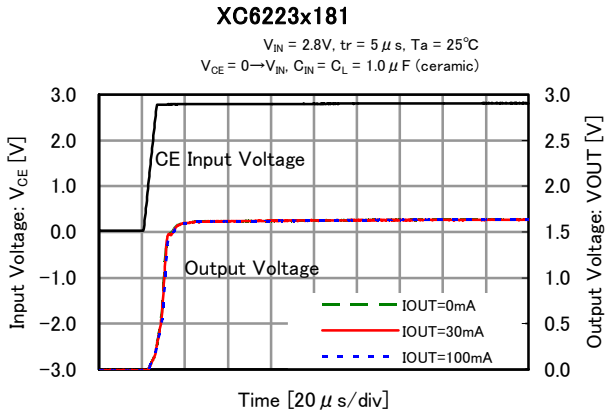






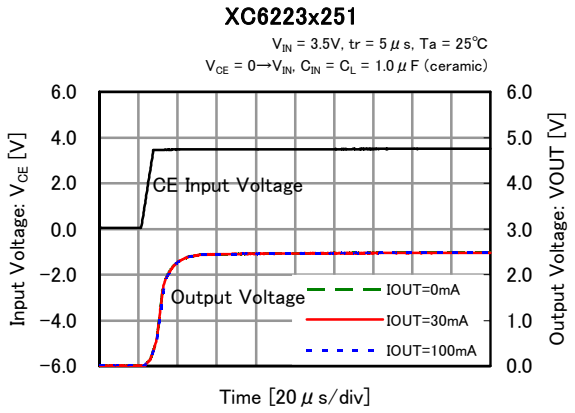
(9) CE Rising Response Time (A,B,C,D Type)

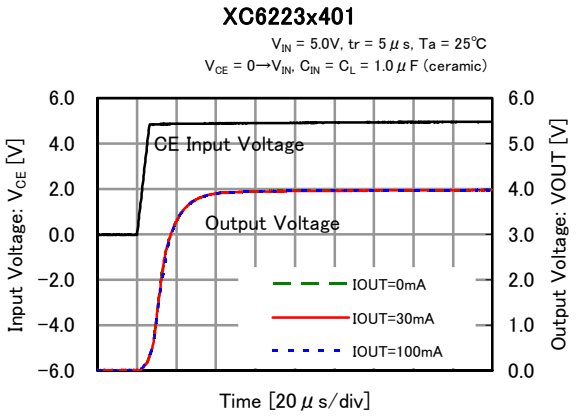




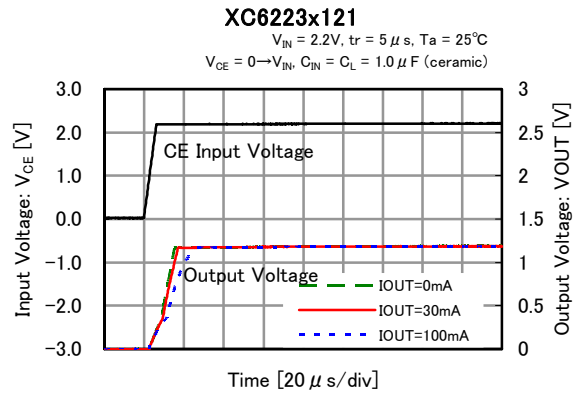
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

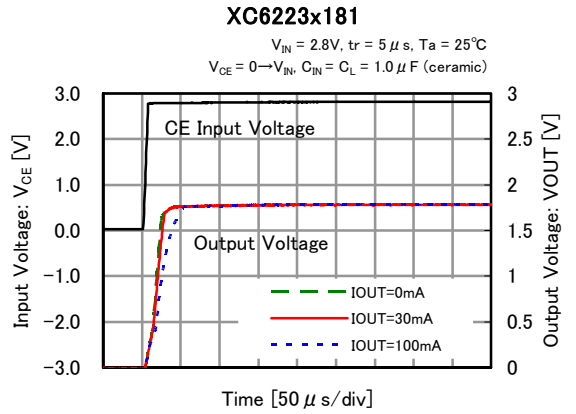
(9) CE Rising Response Time (A,B,C,D Type) (Continued)

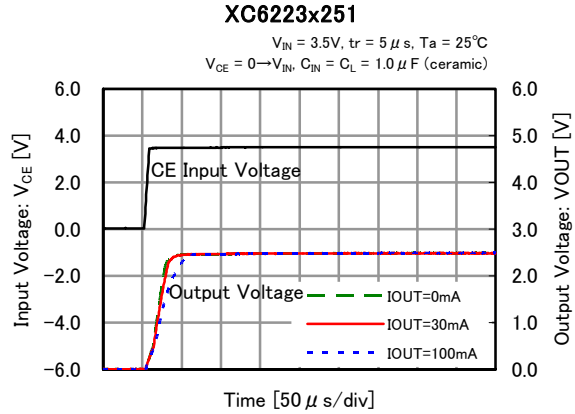


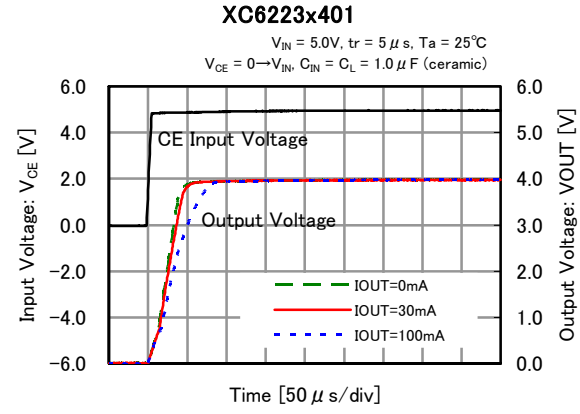


(9) CE Rising Response Time (E,F,G,H Type) (Continued)







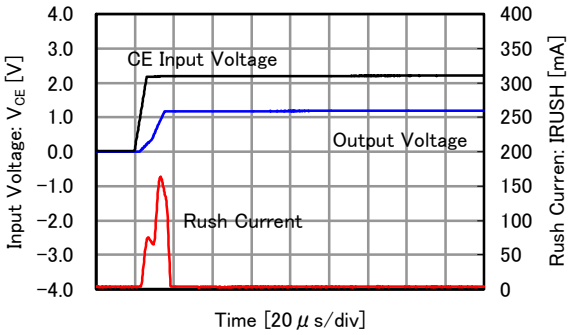


■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(10) Inrush Current Response Time (E,F,G,H Type)

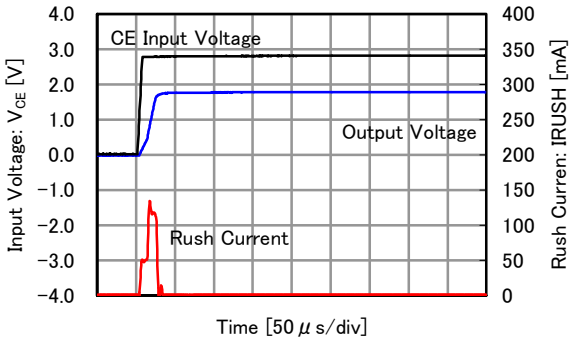
XC6223x121

V_{IN} = 2.2V, tr = 5μs, Ta = 25℃
V_{CE} = 0→V_{IN}, C_{IN} = C_L = 1.0μF (ceramic)



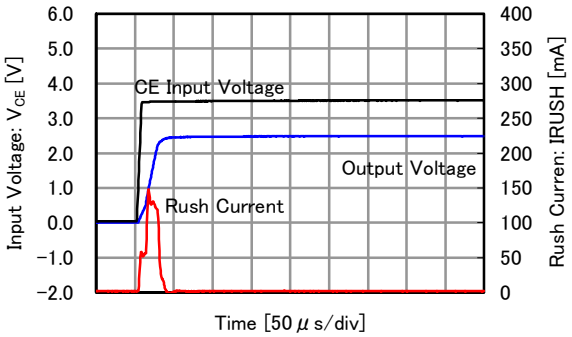
XC6223x181

V_{IN} = 2.8V, tr = 5μs, Ta = 25℃
V_{CE} = 0→V_{IN}, C_{IN} = C_L = 1.0μF (ceramic)



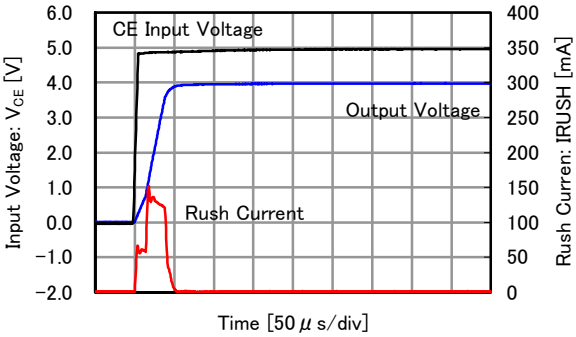
XC6223x251

V_{IN} = 3.5V, tr = 5μs, Ta = 25℃
V_{CE} = 0→V_{IN}, C_{IN} = C_L = 1.0μF (ceramic)



XC6223x401

V_{IN} = 5.0V, tr = 5μs, Ta = 25℃
V_{CE} = 0→V_{IN}, C_{IN} = C_L = 1.0μF (ceramic)

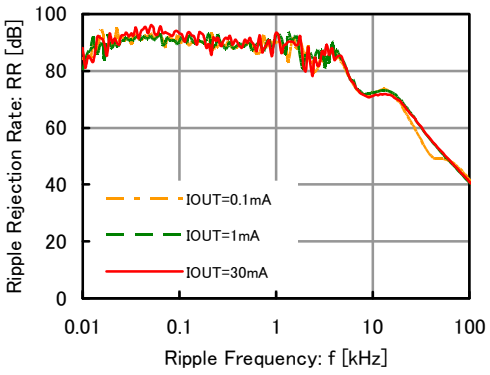


■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(11) Ripple Rejection Rate

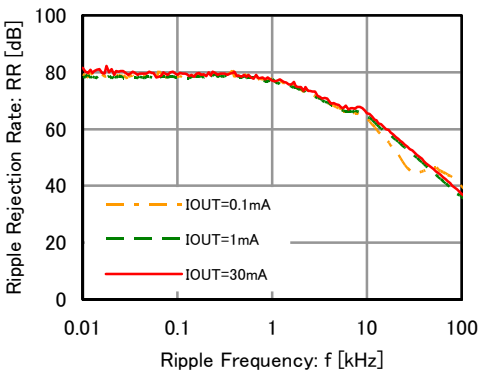
XC6223x121

Ta = 25℃, V_{IN} = 3.0VDC+0.5Vp-pAC
C_{IN} = 0.1μF (ceramic), C_L = 1μF (ceramic)



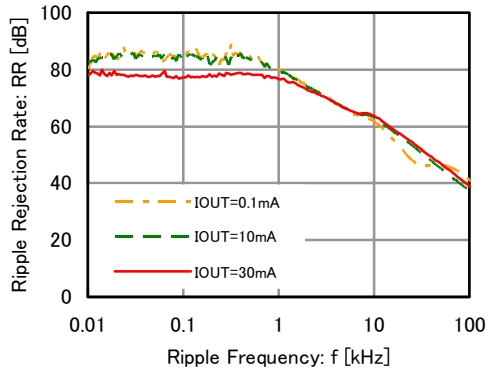
XC6223x181

Ta = 25℃, V_{IN} = 3.0VDC+0.5Vp-pAC
C_{IN} = 0.1μF (ceramic), C_L = 1μF (ceramic)



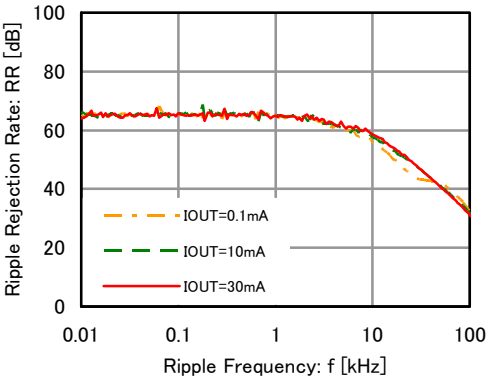
XC6223x251

Ta = 25℃, V_{IN} = 3.5VDC+0.5Vp-pAC
C_{IN} = 0.1μF (ceramic), C_L = 1μF (ceramic)



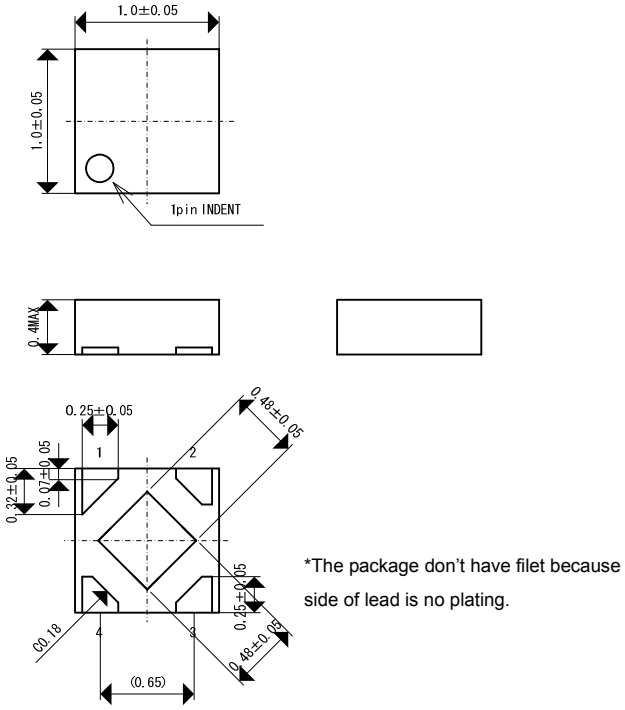
XC6223x331

Ta = 25℃, V_{IN} = 4.3VDC+0.5Vp-pAC
C_{IN} = 0.1μF (ceramic), C_L = 1μF (ceramic)



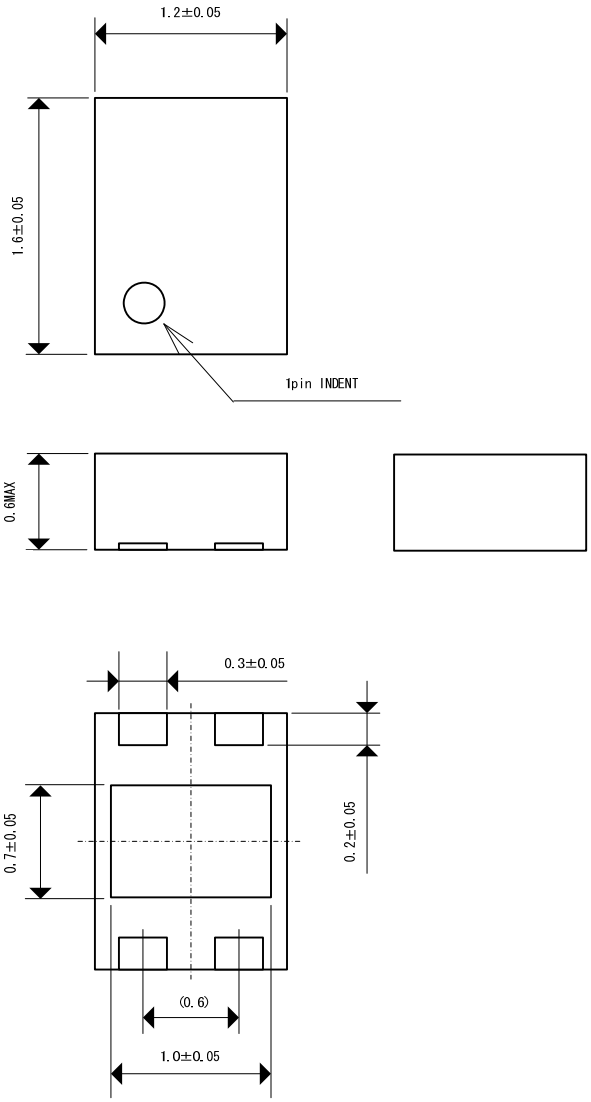
■PACKAGING INFORMATION

USPQ-4B03
(unit : mm)



*The package don't have filet because side of lead is no plating.

USP-4
(unit : mm)



SSOT-24
(unit : mm)